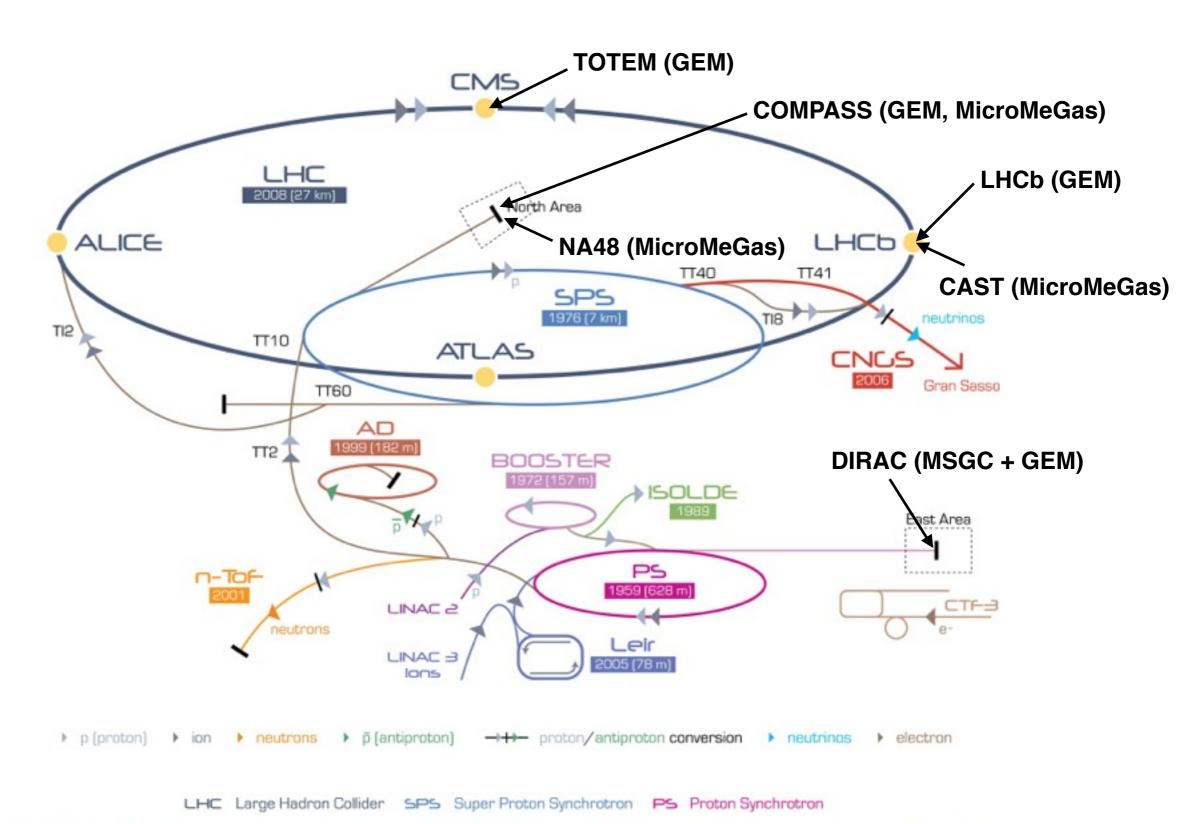
# Review of Micro-Pattern Gaseous Detectors

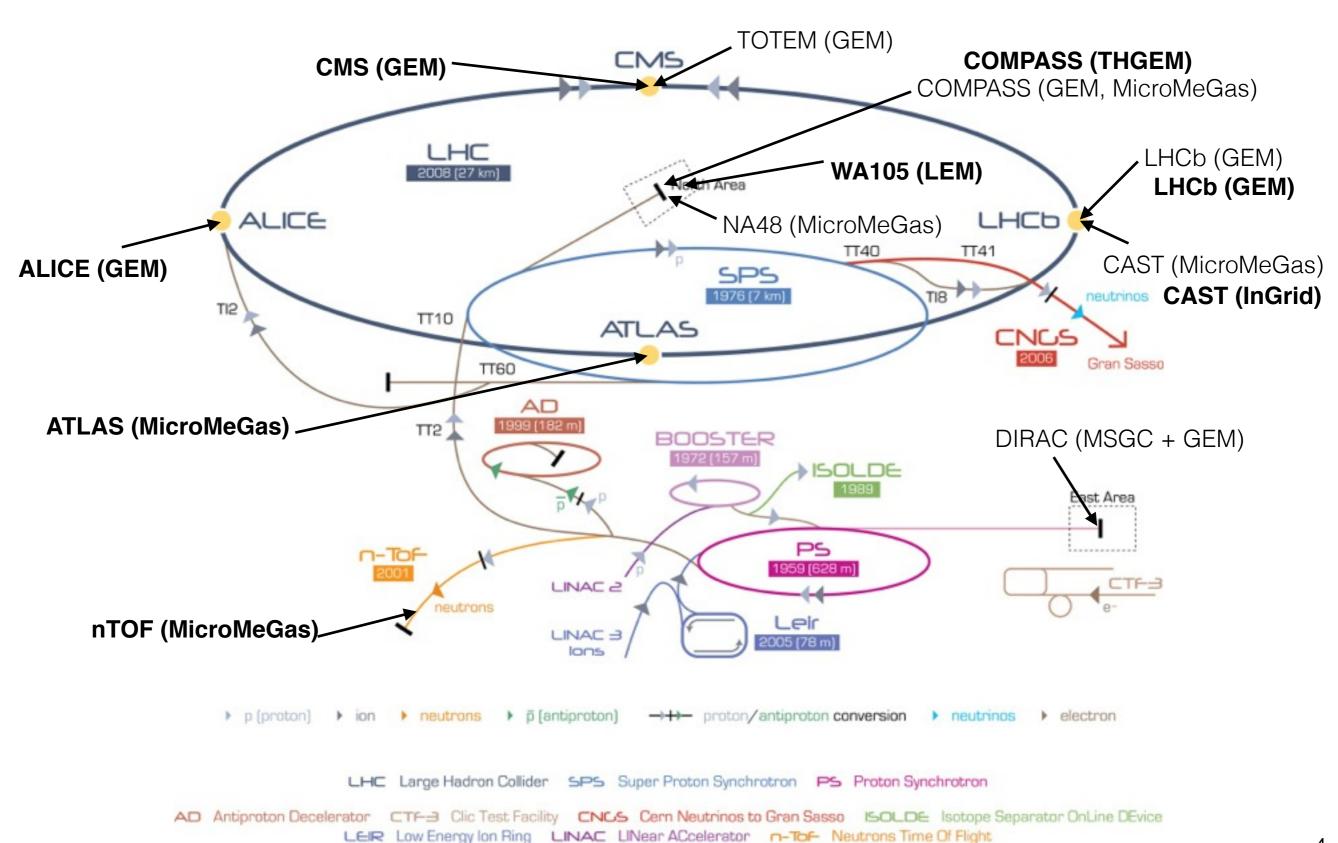
Filippo Resnati (CERN)

I'll only mention the CGEM in this slide

# An example



#### In the future



# MPGD highlights

- High flux capability
- High gain
- High space resolution
- Good time resolution
- Good energy resolution
- Excellent radiation hardness
- Good ageing properties
- Large size
- Low cost

#### MVPC Charpak, 1968

Few primary electron and ion pairs in gas Charge amplification in gas via Townsend avalanche High field region confined to preserve detector linearity

Small electrode curvature defines field drop with distance-> wires

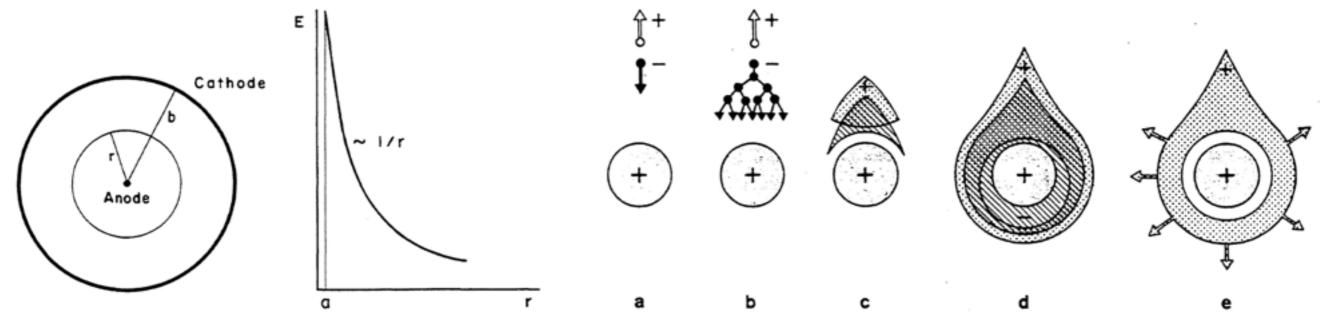


Fig. 48 The coaxial cylindrical proportional counter, Fig. 49 and the shape of the electric field around the thin anode. Only very close to the anode the field grows high enough to allow avalanche multiplication.

Time development of an avalanche in a proportional counter<sup>30</sup>). A single primary electron proceeds towards the anode, in regions of increasingly high fields, experiencing ionizing collisions; due to the lateral diffusion, a drop-like avalanche, surrounding the wire, develops. Electrons are collected in a very short time (1 nsec or so) and a cloud of positive ions is left, slowly migrating towards the cathode.

F. Sauli, "Principles of Operation of Multiwire Proportional and Drift Chambers," CERN-77-09

Ions (slowly) drift back -> space charges -> field modifications -> rate capability Electrostatics forces -> distance between wires -> position resolution Organic molecules/pollutants -> modification of wire radius -> *classical* ageing

# Change of paradigm (1)

In order to evacuate the ionic charge fast, the cathode electrodes are placed in the vicinity of the anode electrodes.

#### MSGC Oed, 1988

Electrodes on solid substrate -> smaller pitch -> higher resolution Cathodes in the vicinity of the anode -> fast evacuations of ions -> high flux capability

Semiconductor industry technologies: photolithography, etching, lift-off, coating, ...

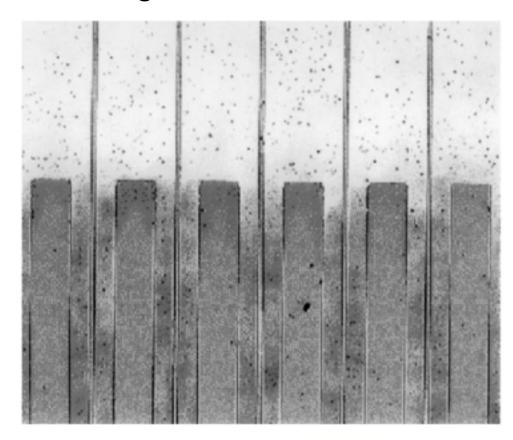


Figure 1 Close view of one of the first microstrip plates developed by Oed at the Institut Laue-Langevin. On an insulating substrate, thin metallic anode strips alternate with wider cathodes; the pitch is  $200 \ \mu m$ .

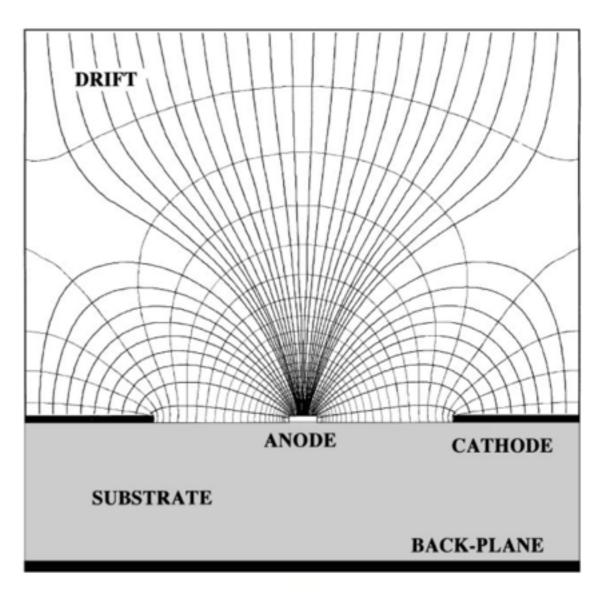


Figure 2 Equipotentials and field lines in the microstrip chamber, computed close to the substrate. The back-plane potential has been selected to prevent field lines entering the dielectric.

F. Sauli and A. Sharma, "Micropattern Gaseous Detectors," Annu. Rev. Nucl. Part. Sci. 49 (1999) 341

#### MSGC Oed, 1988

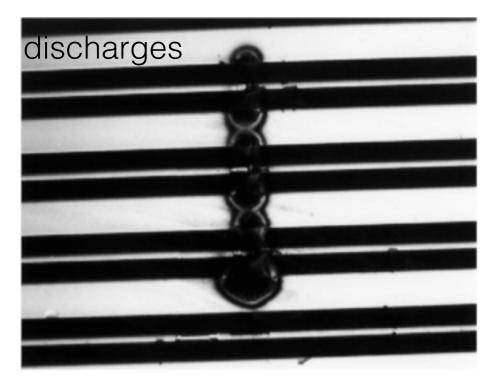


Figure 19 Close view of the strips on a plate in the region of a discharge. Note extensive damage to the strips.

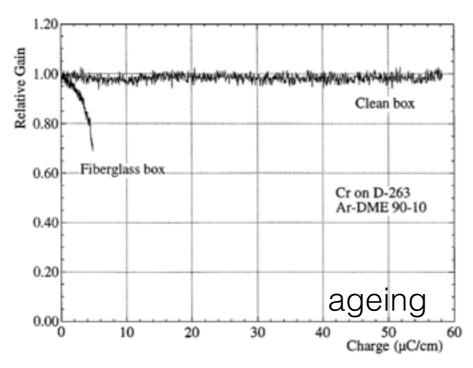


Figure 21 Comparison of aging rate under irradiation for identical plates, mounted either in a conventional fiberglass assembly or in a clean container.

Annu. Rev. Nucl. Part. Sci. 49 (1999) 341

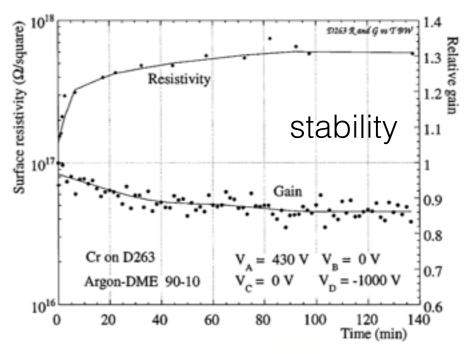


Figure 7 Initial gain variation of gain and resistivity as a function of time from the application of voltage for a plate made on insulating borosilicate glass substrate. VA, VB, VC, and VD are the anode, back-plane, cathode, and drift potentials, respectively.

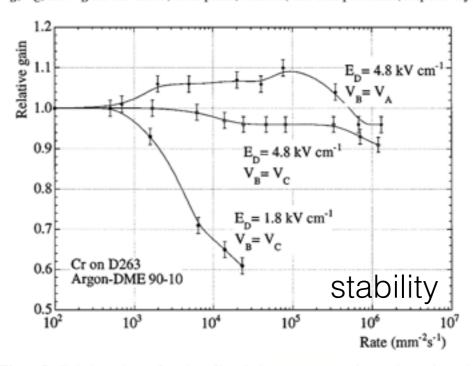


Figure 8 Relative gain as a function of irradiation rate, measured on a microstrip made on borosilicate glass. The performance depends strongly on the applied voltages. Ep is the drift field; VB and VC are the back-plane and cathode potentials.

F. Sauli, "Development of High Rate MSGCs: Overview of Results From RD-28," Nucl. Phys. Proc. Suppl. 61B (1998) 236

#### Certainly some issues:

- Modification of the electric field by substrate polarisation
- Charging up of the insulator by electrons and ions produced in the avalanches
- Ion migration within the substrate
- Permanent deterioration (ageing) during sustained irradiation

#### Nevertheless

Use of a substrate with lower resistivity and electronic conductivity eliminates the polarisation and surface charging processes up to very high rates; it results also in more stable operation and reduced ageing rates.

Topical session on resistive coating on 9th of December at RD51 Mini-Week

# Change of paradigm (2)

In order to reduce the effects of the discharges and the *classical* ageing, the electric field responsible for the charge amplification is shaped by extended electrodes

# MPGD: a rich variety

Non-exhaustive list

	mesh	type	hole
micro	MicroGap		MicroPin
	MSGC MicroWire		MicroPic MicroDot
electrode		MHSP	
extended	MicroMeGas  CAT  InGrid  GridPix	Micro-bulk MM Micro-RWell MicroGroove MicroWell RPWell	GEM TH-GEM GEMpix LEM

# "Parallel plate"

In some circumstances, small dependance of the gain vs gap (pressure) Better energy resolution... even on large surfaces

Gap on large surfaces controlled with dielectric material and spacers

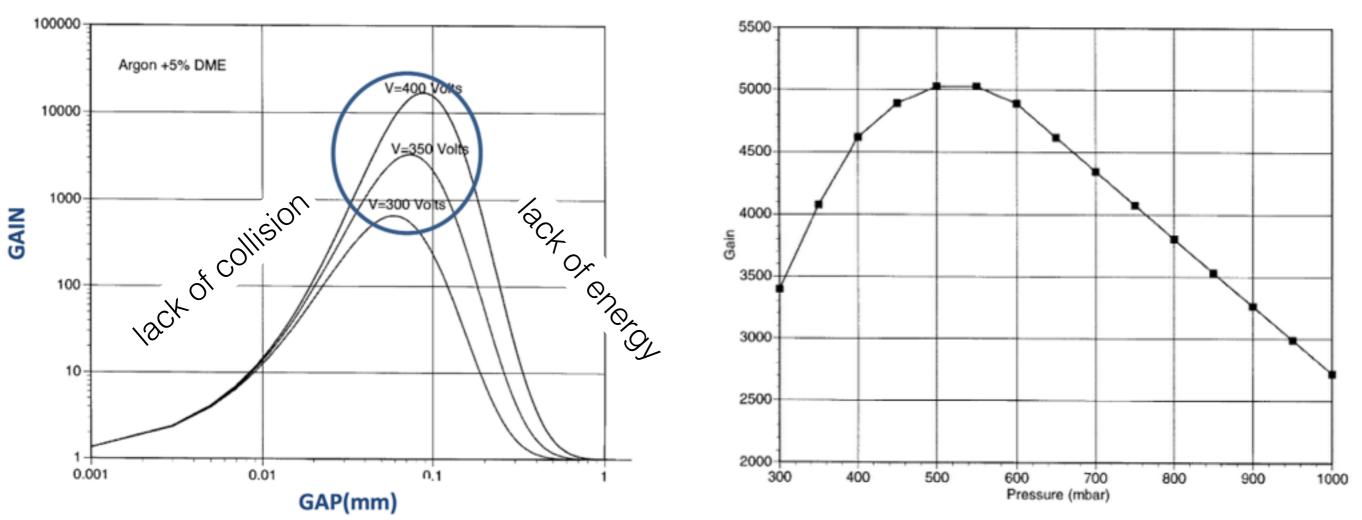


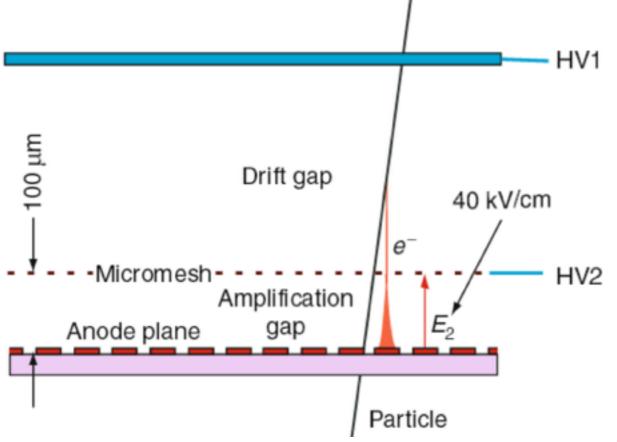
Fig. 3. Gain versus pressure for a gas mixture of Ar + 7% cyclohexane for a 50 μm amplification gap. The drift and the voltage was 1000 and 270 V, respectively.

Y. Giomataris, "Development and prospects of the new gaseous detector 'Micromegas'," NIM A419 (1998) 239

#### Meshes: MicroMeGas

Y. Giomataris *et al.* "MICROMEGAS: A High granularity position sensitive gaseous detector for high particle flux environments," Nucl. Instr. and Meth. A 376 (1996) 29

Small gap, high field: fast movement of ions that are mostly collected on the mesh: small space-charge and very fast signals



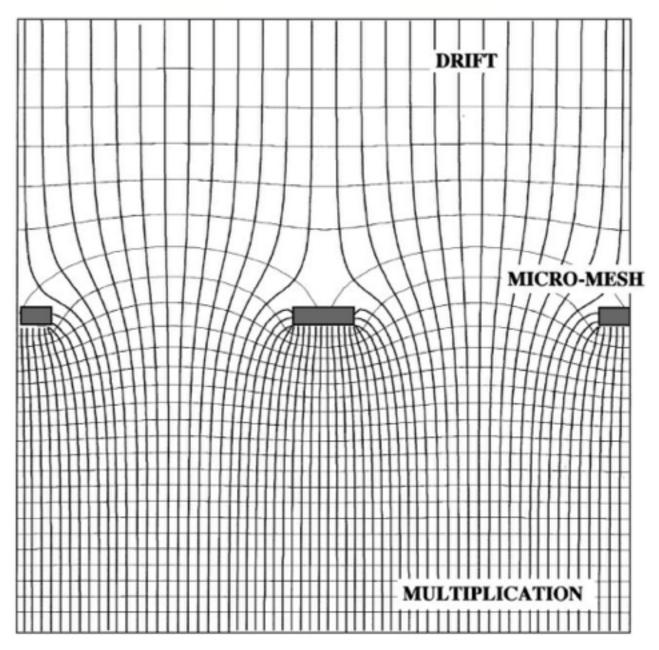
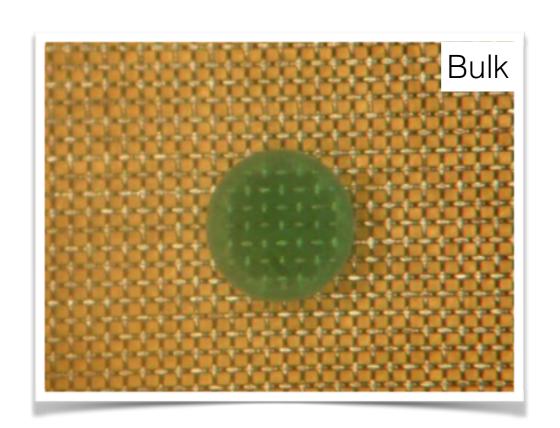
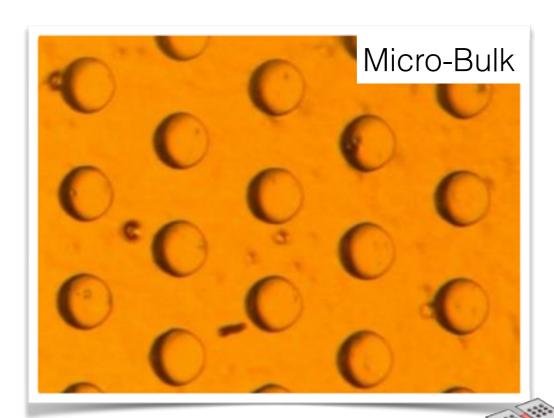


Figure 28 Schematics and electric field map in the micromegas. A metallic micromesh separates a low-field, or drift, region from the high-field multiplication region.

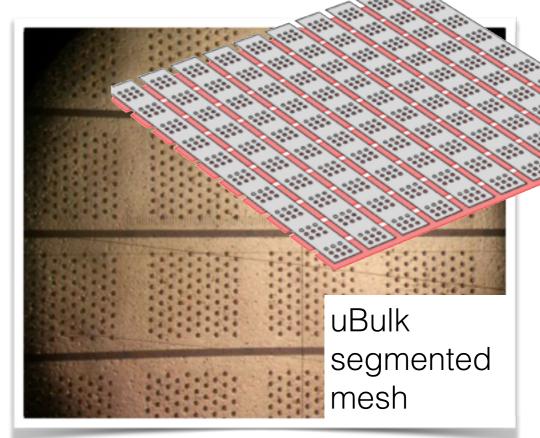
Annu. Rev. Nucl. Part. Sci. 49 (1999) 341

## Bulk, uBulk and no bulk



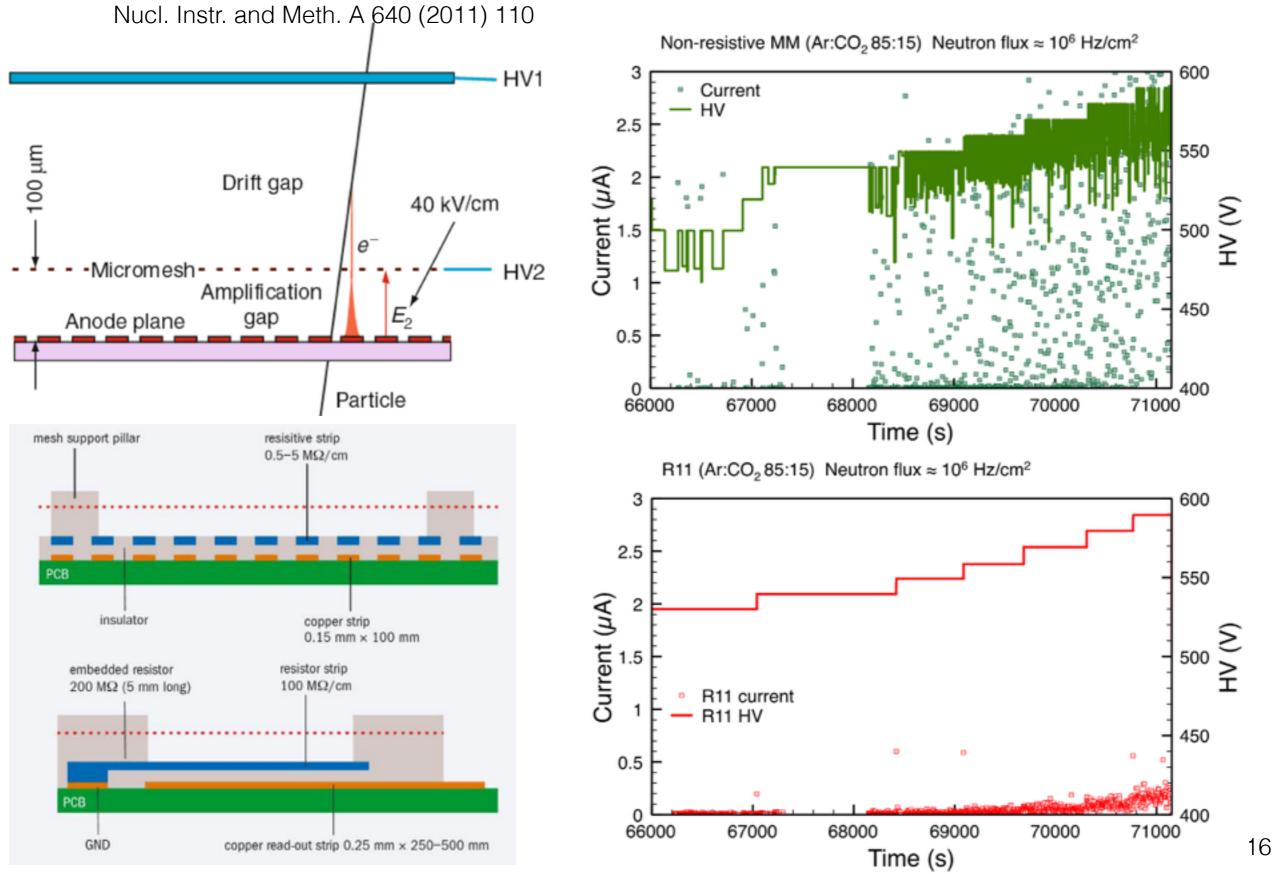






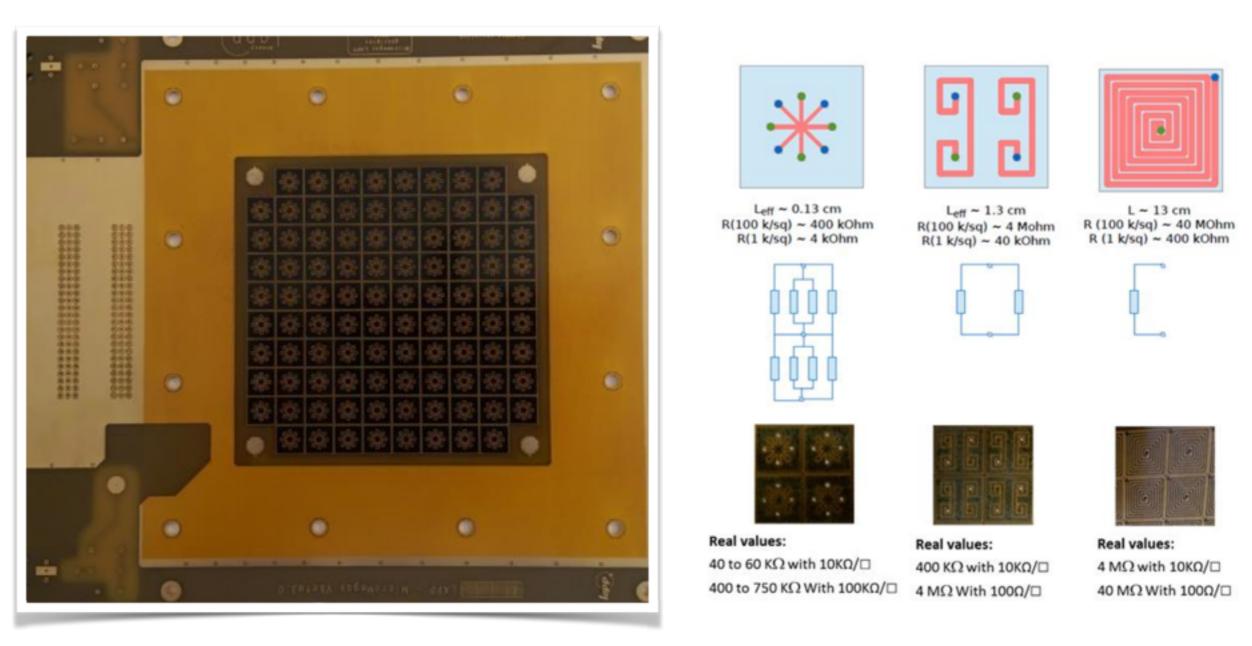
#### Resistive

T. Alexopoulos *et al.* "A spark-resistant bulk-micromegas chamber for high-rate applications,"



# Discrete (buried) resistors

Charge evacuated *vertically*, not along the surface



Applied to calorimetry with MPGDs - M. Chefdeville et al.

#### Holes: GEM

F. Sauli, "GEM: A new concept for electron amplification in gas detectors," Nucl. Instr. and Meth. A 386 (1997) 531

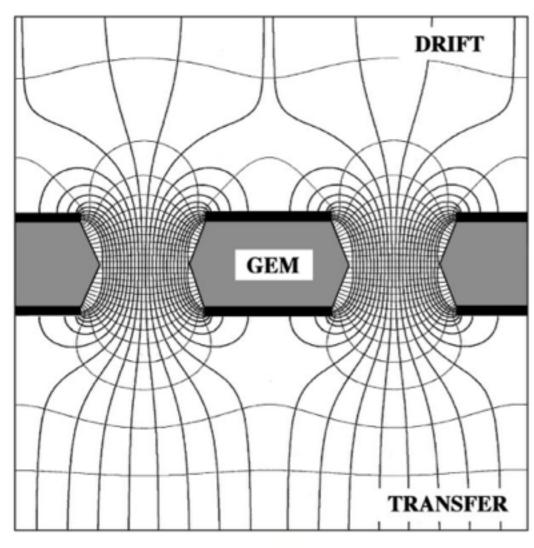
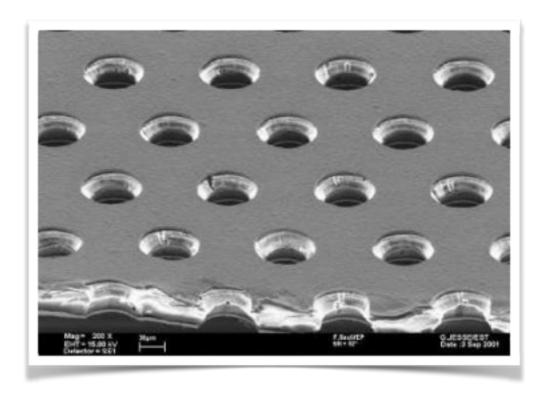


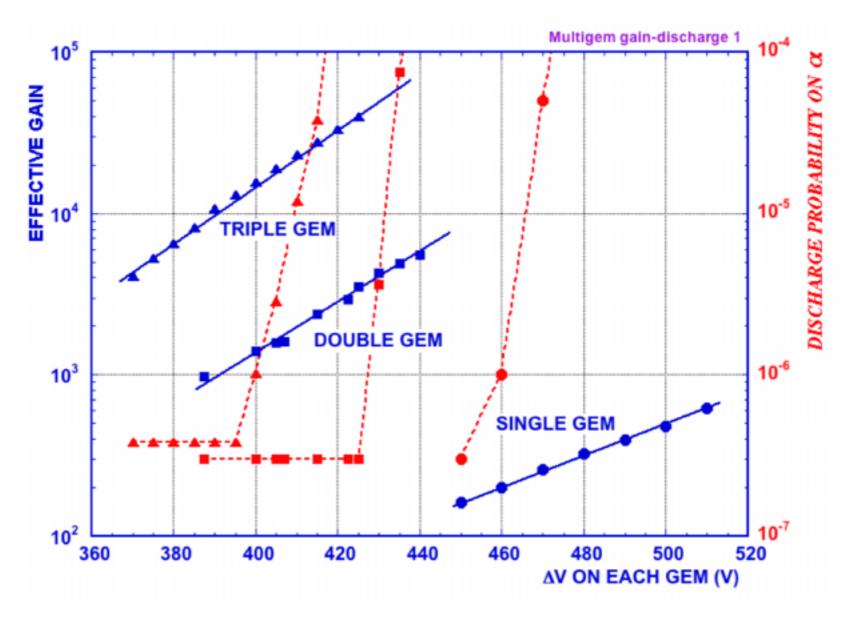
Figure 34 Electric field and equipotentials lines in the gas electron multiplier.

Polyimide film metal cladded on both sides with holes chemically etched



# Sharing the task

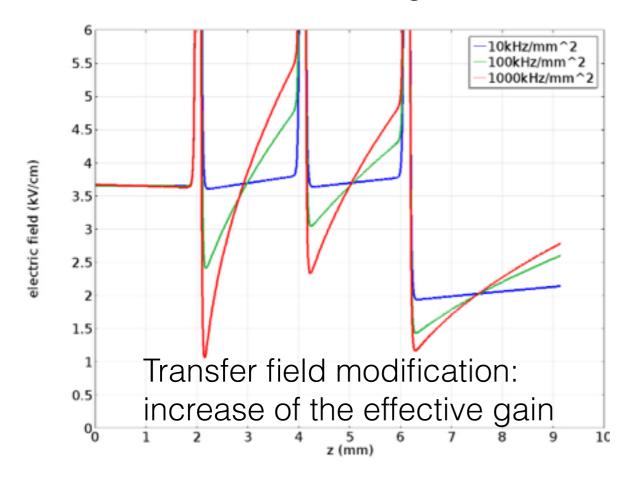
Unique feature of GEMs is charge transfer (electrons exit)
Share the gain between two or more GEM foils in cascade to reduce the discharge probability and the discharge effects Mixed/Hybrid detector (GEM + MM, ...) also used



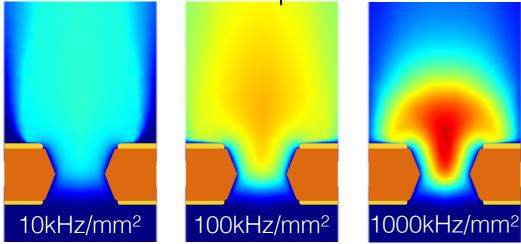
S. Bachmann et al, NIMA 479(2002)294

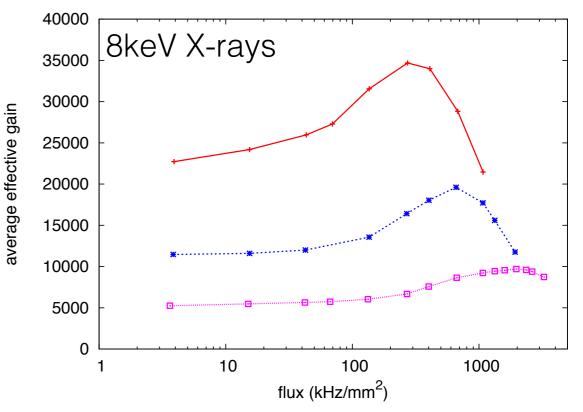
# High flux capabilities

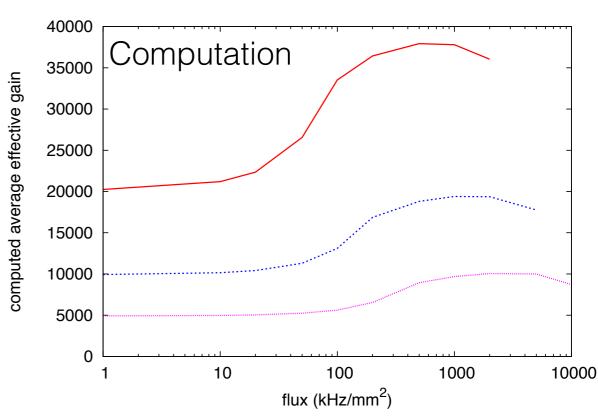
Ion charges instantaneously modify the electric fields



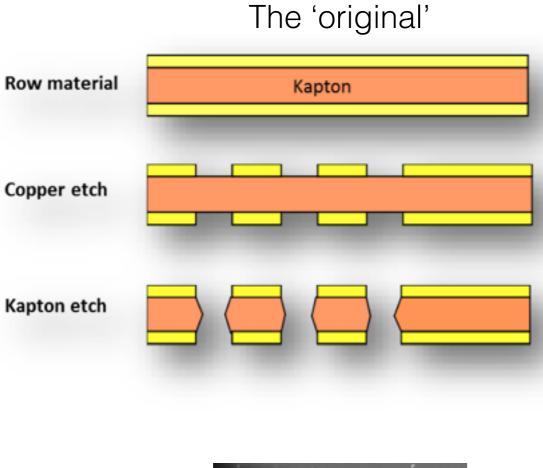
Ion distribution at the hole entrance: reduction of the amplification field

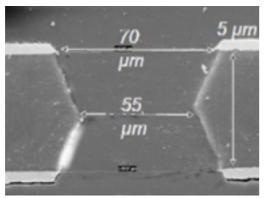


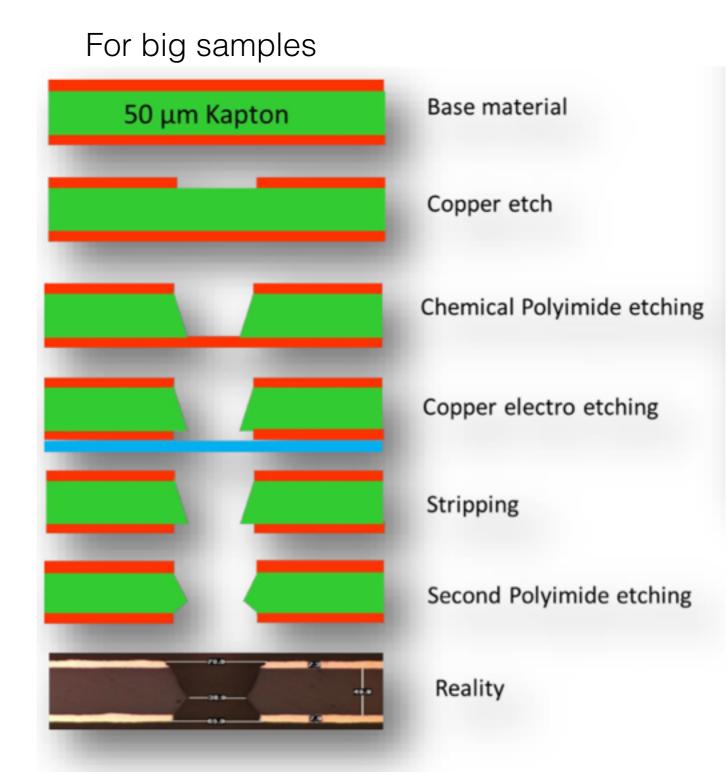




## Production: two ways







# And are indeed big

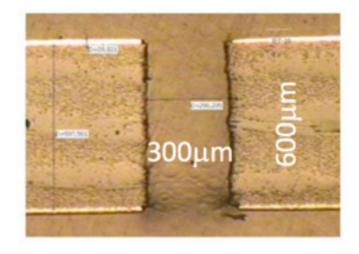
CMS muon system upgrade with GEM

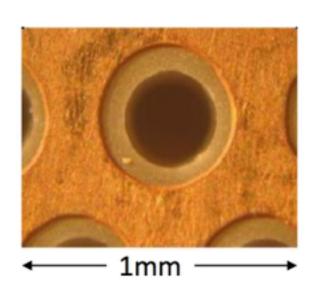


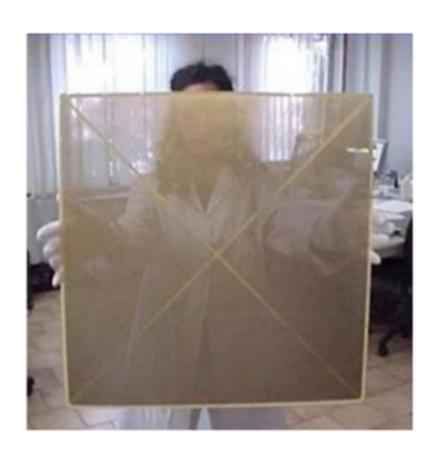
### THGEM

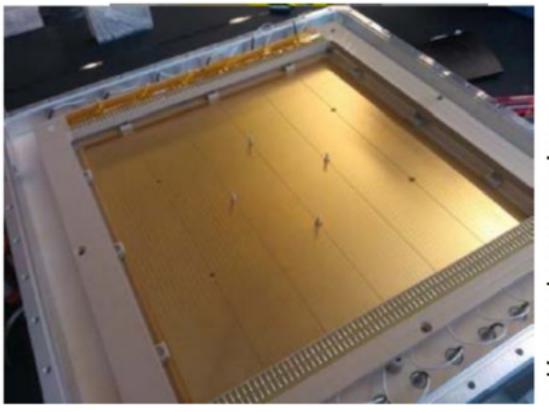
10x thicker than GEMs
Typical mechanical drilled holes
Typically in Glass Epoxy
Robust and self-sustained





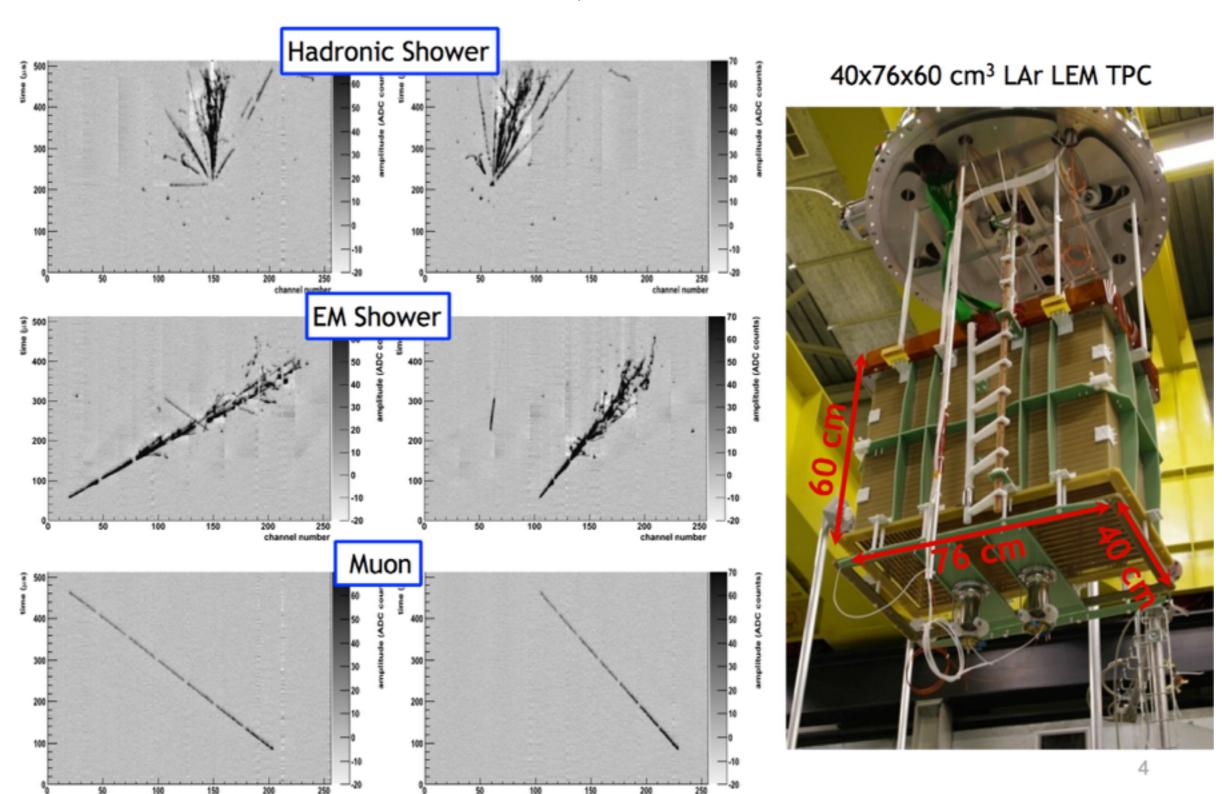






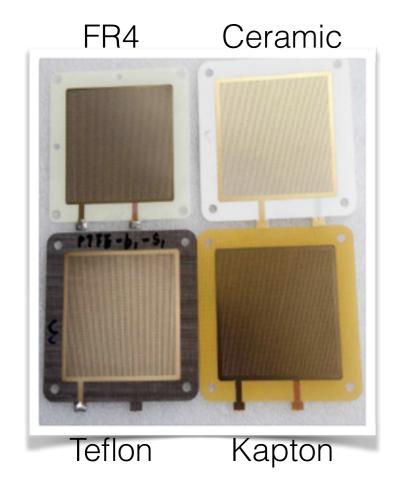
# Also in cryogenic

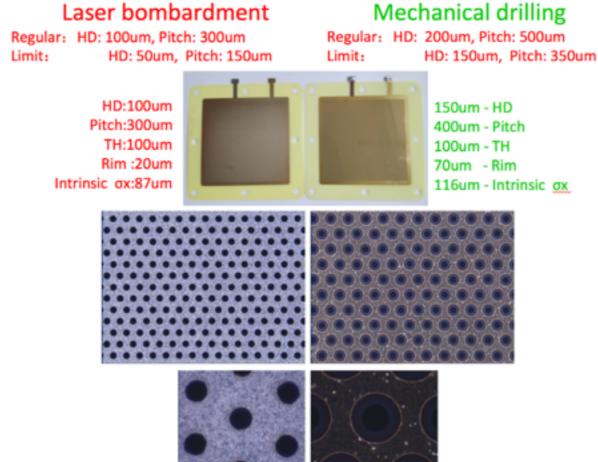
S. Wu, "Recent results of double phase LAr LEM TPC R&D," MPGD2015



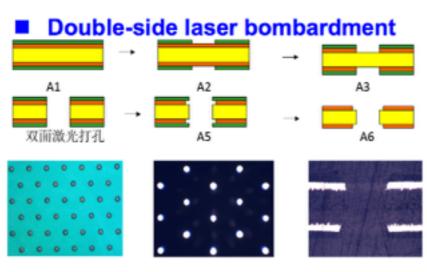
#### Also other materials

Y. Xie, "New substrate, high spatial resolution and big-area THGEMs: development and applications," MPGD2015

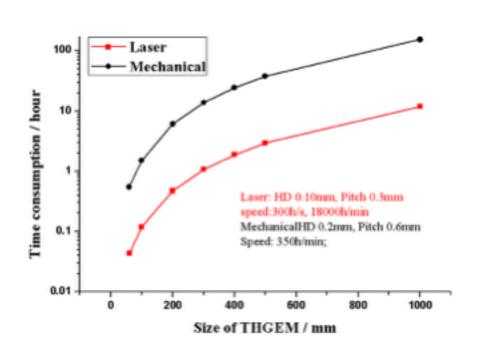




And other methods: Laser bombardment faster and finer



Both FR-4 and Kapton is OK. Six main steps. The key step is double-side bombardment



#### And more materials

T. Fujiwara, "Development and application of Scintillating Glass-GEM detector," MPGD2015

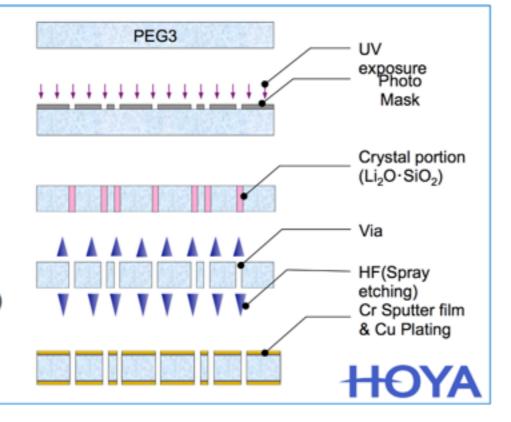
1. Glass Substrate (PEG3)

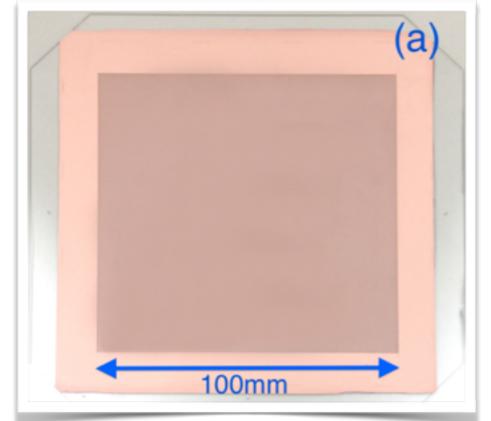
2. UV exposure (1st\_exp)

Crystal formation (heat treatment)

Via etching (hydrogen fluoride wet etching)

5. Cr sputter & Cu plating





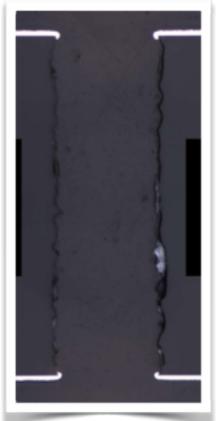
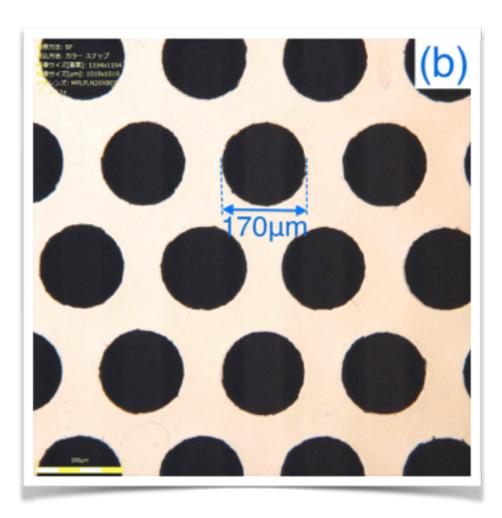
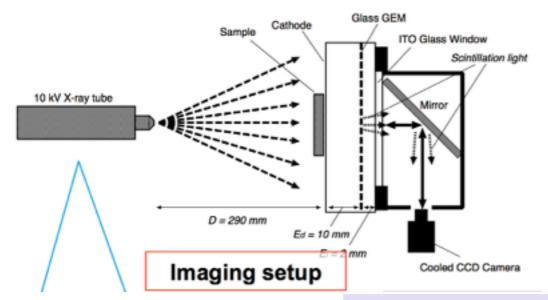


Photo Etchable Glass 3 (PEG3) UV laser + wet etching

Glass can be very clean Suitable for operation in sealed mode

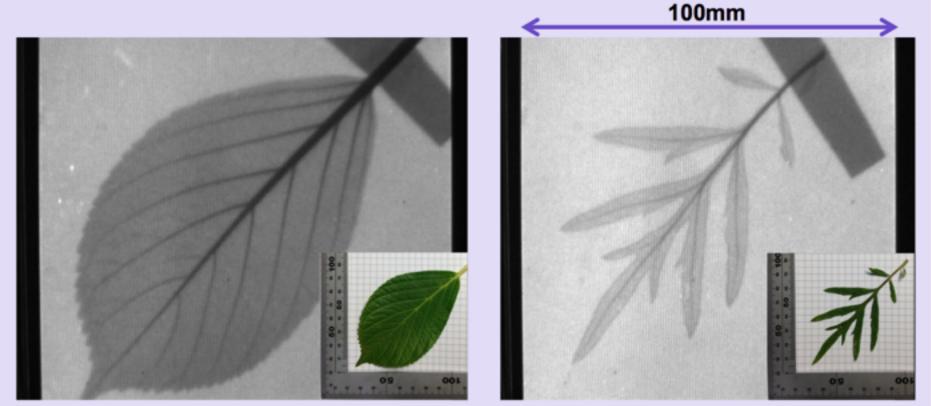


# 'Scintillating GEM'



T. Fujiwara, "Development and application of Scintillating Glass-GEM detector," MPGD2015

It's the ArCF<sub>4</sub> that scintillates during the electron avalanche and it does it in the visible



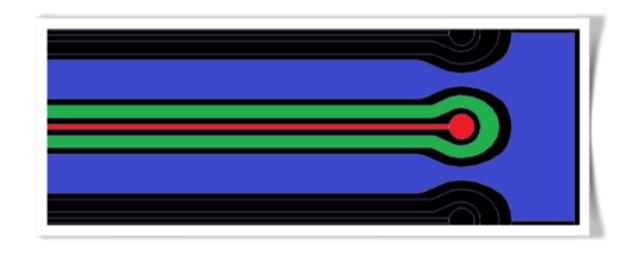
Obtained image of leaves (2 sec integration time)[10]

Excellent spatial resolution ≈500µm Quick imaging of low Z material with low energy X-rays (≈7 keV)

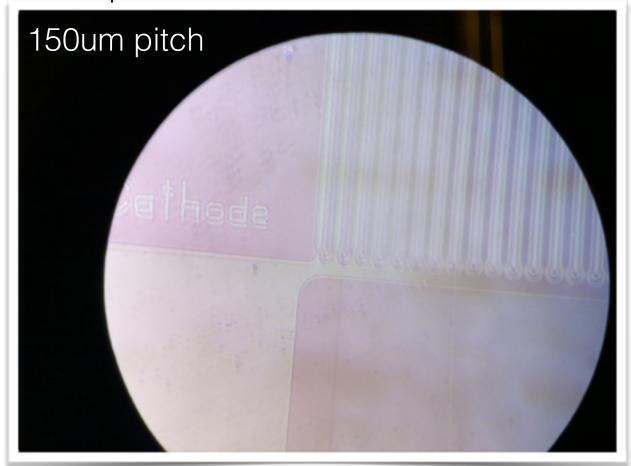
# LCD technologies

H. Takahashi, "Development of a transparent Single-grid-type MSGC based on LCD technology," MPGD2015

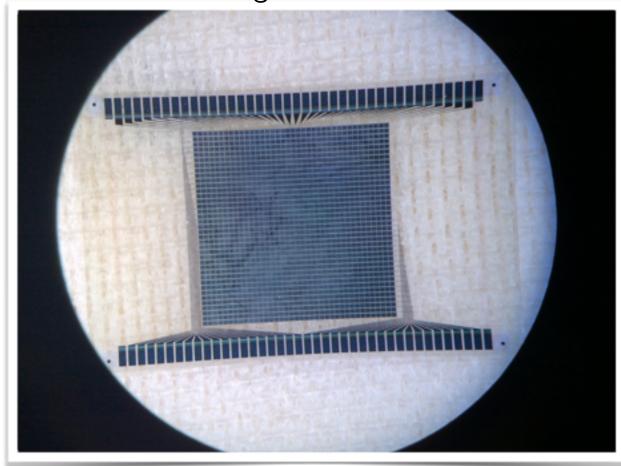
MSGC with 'Grid' electrode to control gain and reduce spark probability By SHARP



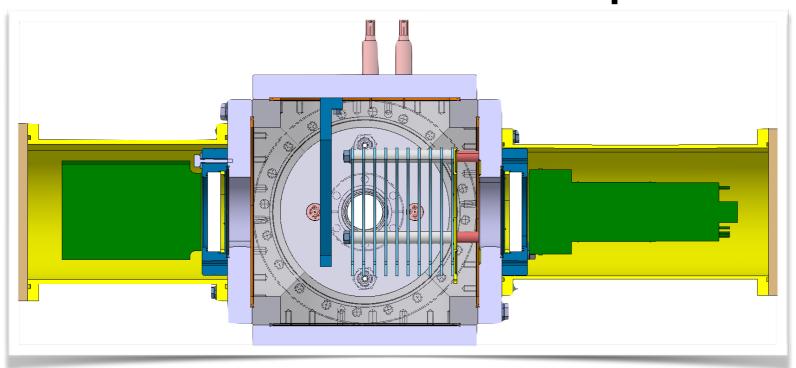
Transparent MSGC with IZO electrodes!



TFT integrated electronic



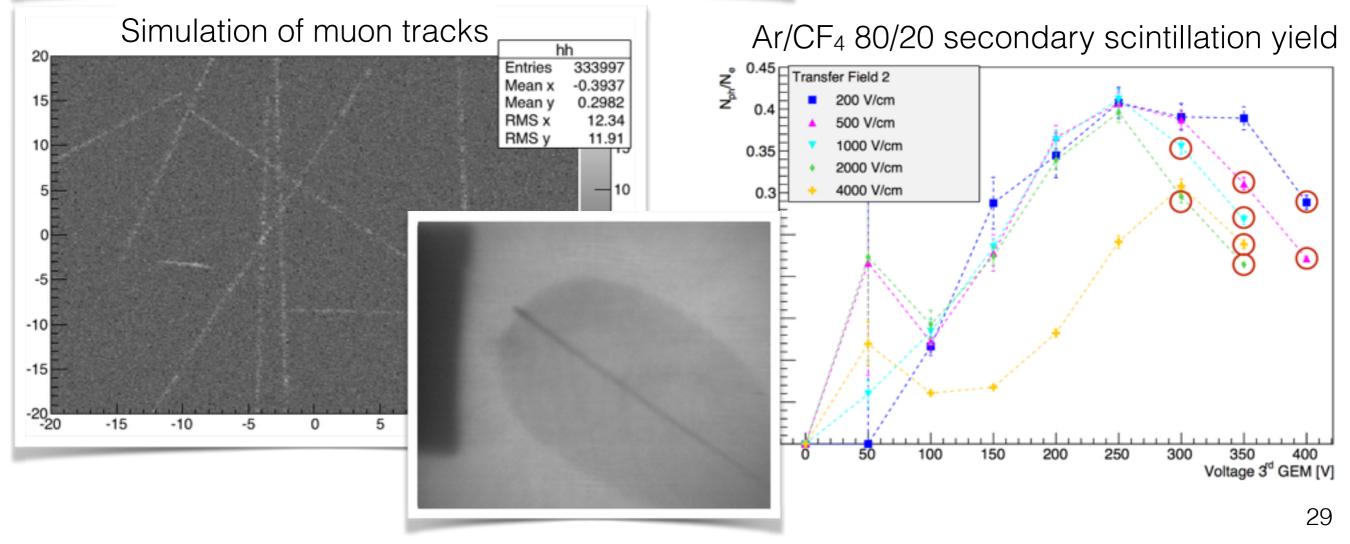
# TPC with optical readout



With triple GEM amplifier Study:

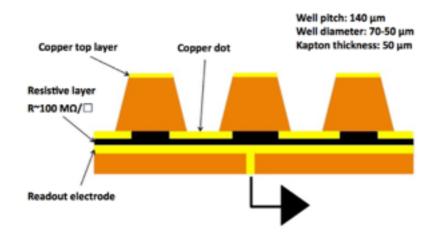
- Visible (near UV and near IR) scintillation of gasses
- Event topology study
- Imaging

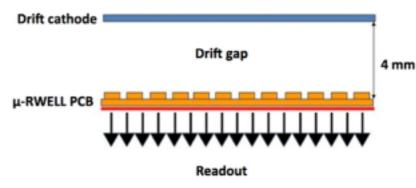
- . .



#### Micro RWELL

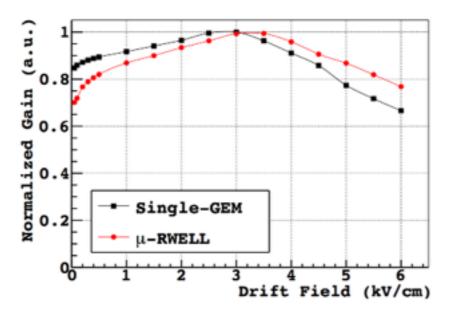
G. Bencivenni *et al.*, "The micro-Resistive WELL detector: a compact spark-protected single amplification-stage MPGD," 2015 JINST 10 P02008





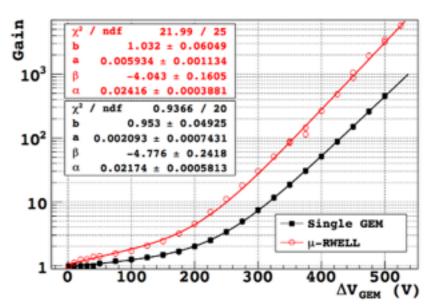
See Lener's talk

Figure 1. Schematic drawing of the  $\mu$ -RWELL PCB.



**Figure 7**. Relative charge collection efficiency as a function of the drift field with a gain of 2000 in Ar:CO<sub>2</sub> 70:30.

Figure 2. Schematic drawing of the  $\mu$ -RWELL detector.

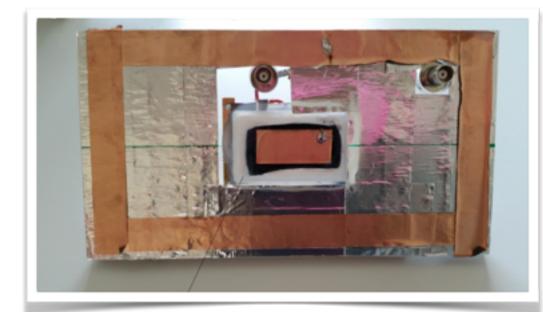


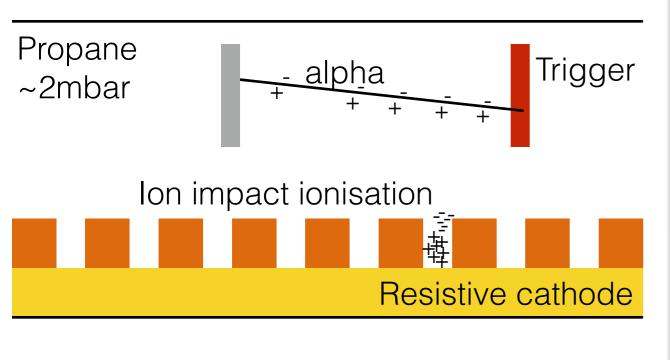
**Figure 8.** Gas gain for the  $\mu$ -RWELL (red points) and the single-GEM (black points) in Ar:CO<sub>2</sub> 70:30.

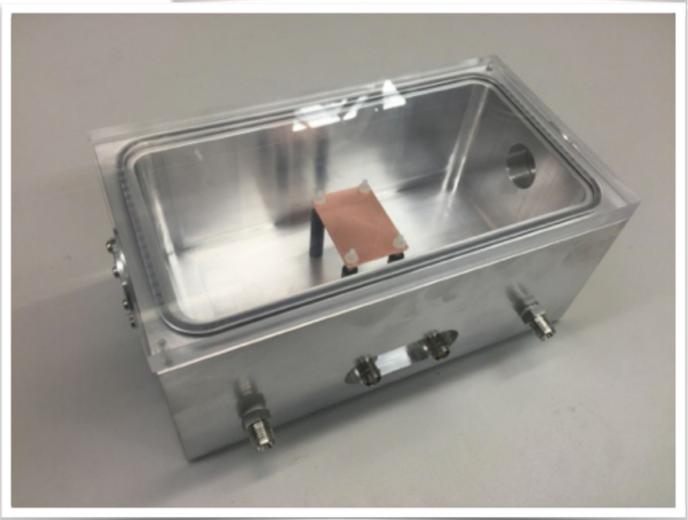
#### Nanodosimetry

Margherita Casiraghi et al.

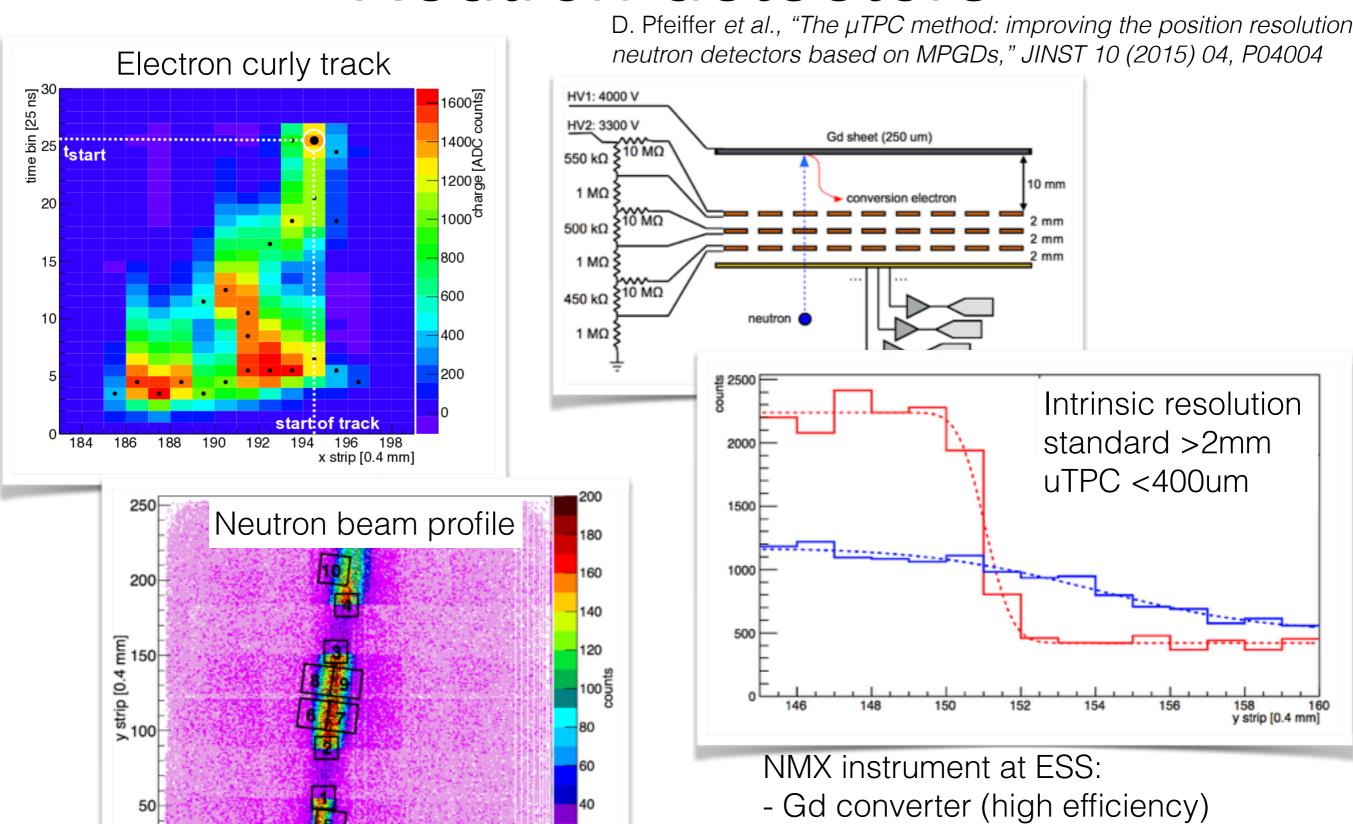
Positive ion TPC in low pressure propane:
Rarefied atoms -> distance -> zoom effect
Ionisation density at the scale of the DNA size
Ions: low diffusion preserve time and spatial information
THGEM based amplification







#### Neutron detectors



150

x strip [0.4 mm]

200

- Triple GEM (high flux capability)

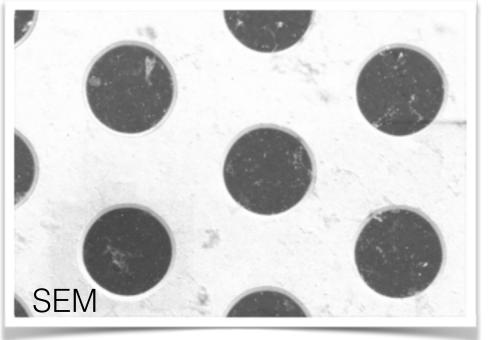
- TPC analysis (improved resolution)

#### Graphene

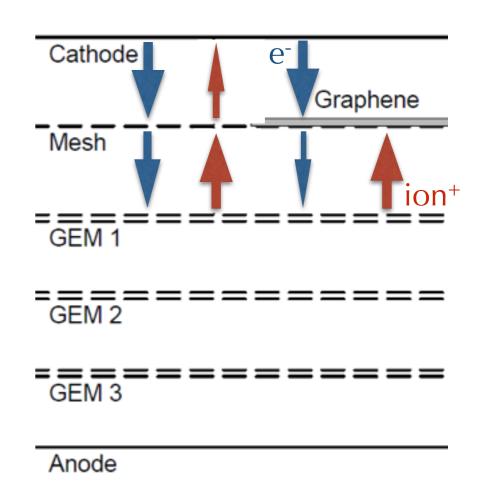
P. Thuiner, "Charge Transfer Properties Through Graphene Layers in Gas Detectors,"

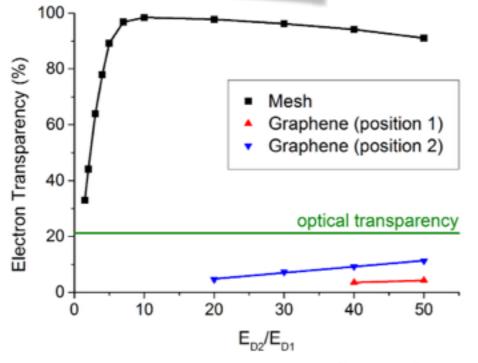
Membrane opaque to ions and transparent to electrons

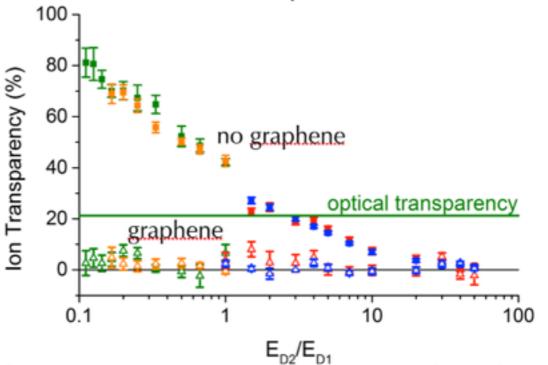
- solution of the ion back-flow in gaseous detectors
- protective layer on photocathodes
- enhancement of electron emission



~99% (suspended) graphene tri-layer coverage



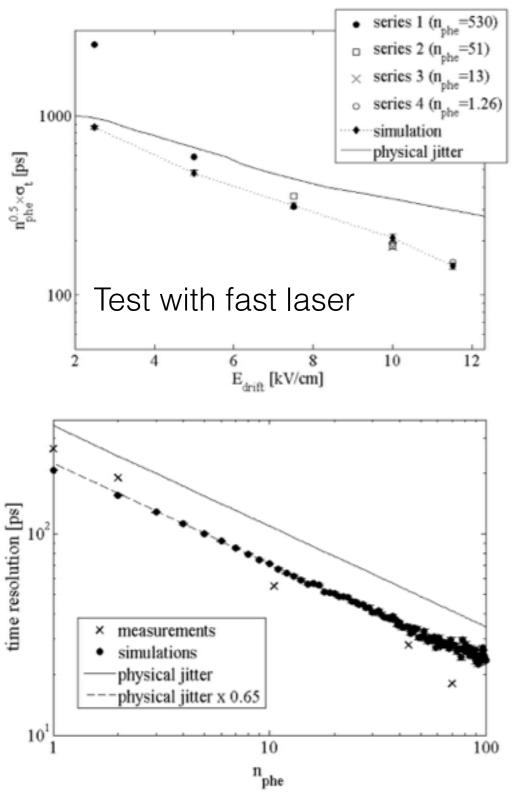


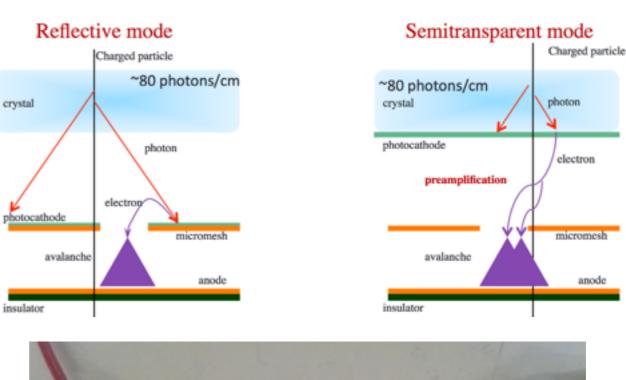


# Time resolution challenge

In gaseous detector the time resolution is limited by the fluctuation in the position of the 'last' primary ionisation cluster. Typically few ns...

Small drift gap (no gas ionisation and small diffusion) primaries all generated at the cathode







T. Papaevangelou, "Fast Timing for High-Rate Environments with Micromegas," MPGD2015

#### Conclusions

Very rich variety of technologies in evolution

Very active community of 'developers' and 'users'

Typically R&D campaign is needed for specific applications users are developers

Extended anode types MPGDs are the most common nowadays, but not the only ones

Several applications, and growing interest outside high energy physics

Large and above all collaborative community behind